MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

OLED MODULE SPECIFICATION

Model : MI12896CO-1

This module uses ROHS material

For Customer's Acceptance:

Customer	
Approved	
Comment	

This specification may change without prior notice in order to improve performance or quality. Please contact Multi-Inno for updated specification and product status before design for this product or release of this order.	Revision	1.0
	Engineering	
	Date	2015-12-25
	Our Reference	

REVISION RECORD

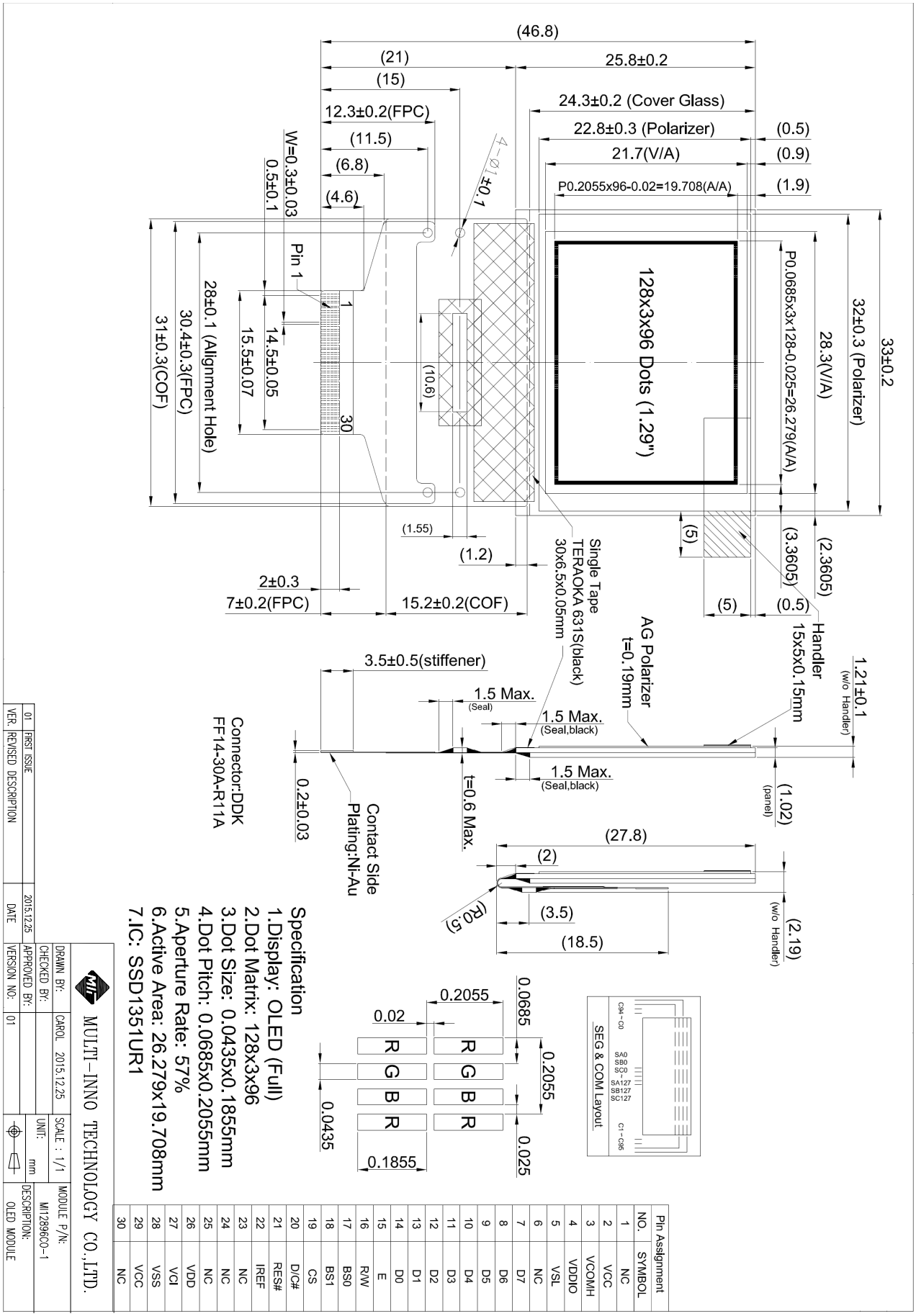
REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2015-12-25	First Release	

CONTENT

■ PHYSICAL DATA

No.	Items	Specification	Unit
1	Display Mode	Passive Matrix OLED	-
2	Display Color	65K/262K	-
3	Duty	1/96	-
4	Resolution	128 (H) x 96 (V)	Pixel
5	Active Area	26.279 (W) x 19.708 (H)	mm^2
6	Outline Dimension	33.00 (W) x 25.80 (H) x 1.21 (D)	mm^3
7	Dot Pitch	0.0685 (W) x 0.2055 (H)	mm^2
8	Dot Size	0.0435 (W) x 0.1855 (H)	mm^2
9	Aperture Rate	57	%
10	Driver IC	SSD1351UR1	-
11	Interface	8-bit 6800/8080-series parallel,SPI	-
12	Weight	2.3±10%	g

■ EXTERNAL DIMENSIONS



Specification
1.Display: OLED (Full)
2.Dot Matrix: 128x3x96
3.Dot Size: 0.0435x0.1855mm
4.Dot Pitch: 0.0685x0.2055mm
5.Aperture Rate: 57%
6.Active Area: 26.279x19.708mm
7.IC: SSD1351UR1

Pin Assignment																														
NO.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30
SYMBOL	NC	VCC	VCOMH	VDDIO	VSL	NC	D7	D6	D5	D4	D3	D2	D1	D0	E	R/W	BS0	BS1	CS	D/C#	RES#	IREF	NC	NC	NC	VDD	VCI	VSS	VCC	NC

VER.	DATE	REVISED DESCRIPTION
01	2015.12.25	FIRST ISSUE

VERSION NO:	APPROVED BY:	CHECKED BY:	DRAWN BY:
01		CAROL 2015.12.25	

MULTI-INNO TECHNOLOGY CO.,LTD.

MODULE P/N:	SCALE : 1/1
MI12896CO-1	UNIT: mm
DESCRIPTION: OLED MODULE	

■ ABSOLUTE MAXIMUM RATINGS

Items	Symbol	Min	Typ.	Max	Unit	Notes
Supply voltage	V_{CI}	-0.3	-	4	V	-
	V_{CC}	8	-	21	V	-
Operating temperature	T_{OP}	-40	-	70	℃	-
Storage temperature	T_{ST}	-40	-	85	℃	-
Life time(90cd/m^2)	-	11,000	-	-	hour	1
Life time(80cd/m^2)	-	12,000	-	-	hour	2
Humidity	-	-	-	85	%RH	-

Note:

(A) Under Vcc = 15V, Ta = 25°C, 50% RH.

(B) Life time is defined the amount of time when the luminance has decayed to less than 50% of the initial measured luminance.

(1) Setting of 90 cd/m^2 :

- Master contrast setting : 0x07
- Frame rate : 105Hz
- Duty setting : 1/96

(2) Setting of 80 cd/m^2 :

- Master contrast setting : 0x06
- Frame rate : 105Hz
- Duty setting : 1/96

■ ELECTRICAL CHARACTERISTICS

◆DC Characteristics

Items	Symbol	Conditions	Min	Typ.	Max	Unit
Analog power supply	V_{CC}		14.5	15	15.5	V
Digital power supply	V_{CI}		2.4	2.8	3.5	V
I/O voltage power supply	V_{DDIO}		1.65	1.8	V_{CI}	V
High level input	V_{IH}	I_{OUT} = 100μA, 3.3MH	0.8 x V_{DDIO}	-	V_{DDIO}	V
Low level input	V_{IL}	I_{OUT} = 100μA, 3.3MH	0	-	0.2x V_{DDIO}	V
High level output	V_{OH}	I_{OUT} = 100μA, 3.3MH	0.9xV_{DDIO}	-	V_{DDIO}	V
Low level output	V_{OL}	I_{OUT} = 100μA, 3.3MH	0	-	0.1xV_{DDIO}	V
Operating current for V_{DD}	I_{DD}		-	170	190	uA
Operating current for V_{DDIO}	I_{DDIO}	External VDD=2.6V	-	0.5	10	uA
		Internal VDD	-	0.5	10	uA
Operating current for V_{CI}	I_{CI}	External VDD=2.6V	-	60	70	uA
		Internal VDD	-	255	280	uA
Operating current for V_{CC}	I_{CC}	External VDD=2.6V	-	1.15	1.26	mA
		Internal VDD	-	1.15	1.26	mA
Segment output current setting	I_{SEG}	Contrast=FF	-	200	-	uA
		Contrast=7F	-	100	-	uA
		Contrast=3F	-	50	-	uA

◆AC Characteristics

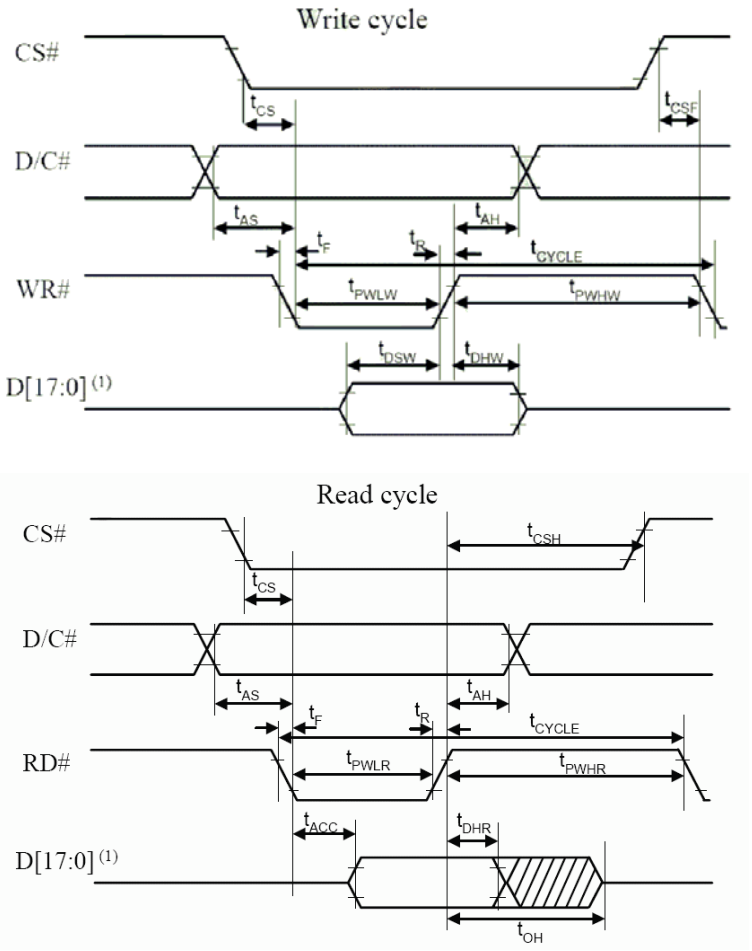
1. 8080-Series MCU Parallel Interface Timing Characteristics

8080-Series MCU Parallel Interface Timing Characteristics

(V_{DD} - V_{SS} = 2.4 to 2.6V, V_{DDIO}=1.65V, V_{CI} = 2.8V, T_A = 25°C)

Symbol	Parameter	Min	Typ	Max	Unit
t_{CYCLE}	Clock Cycle Time	300	-	-	ns
t_{AS}	Address Setup Time	10	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t_{DSW}	Write Data Setup Time	40	-	-	ns
t_{DHW}	Write Data Hold Time	7	-	-	ns
t_{DHR}	Read Data Hold Time	20	-	-	ns
t_{OH}	Output Disable Time	-	-	70	ns
t_{ACC}	Access Time	-	-	140	ns
t_{PWLR}	Read Low Time	150	-	-	ns
t_{PWLW}	Write Low Time	60	-	-	ns
t_{PWHR}	Read High Time	60	-	-	ns
t_{PWHW}	Write High Time	60	-	-	ns
t_R	Rise Time	-	-	15	ns
t_F	Fall Time	-	-	15	ns
t_{CS}	Chip select setup time	0	-	-	ns
t_{CSH}	Chip select hold time to read signal	0	-	-	ns
t_{CSF}	Chip select hold time	20	-	-	ns

8080-series MCU parallel interface characteristics



Note

(1) when 8 bit used: D[7:0] instead; when 16 bit used: [15:0] instead; when 18 bit used: D[17:0] instead.

2. Graphic Display Data Ram Address Map

The GDDRAM is a bit mapped static RAM holding the pattern to be displayed. The RAM size is 128 x 128 x 18bits. For mechanical flexibility, re-mapping on both Segment and Common outputs can be selected by software. Each pixel has 18-bit data. Each sub-pixels for color A, B and C have 6 bits. The arrangement of data pixel in graphic display data RAM is shown below.

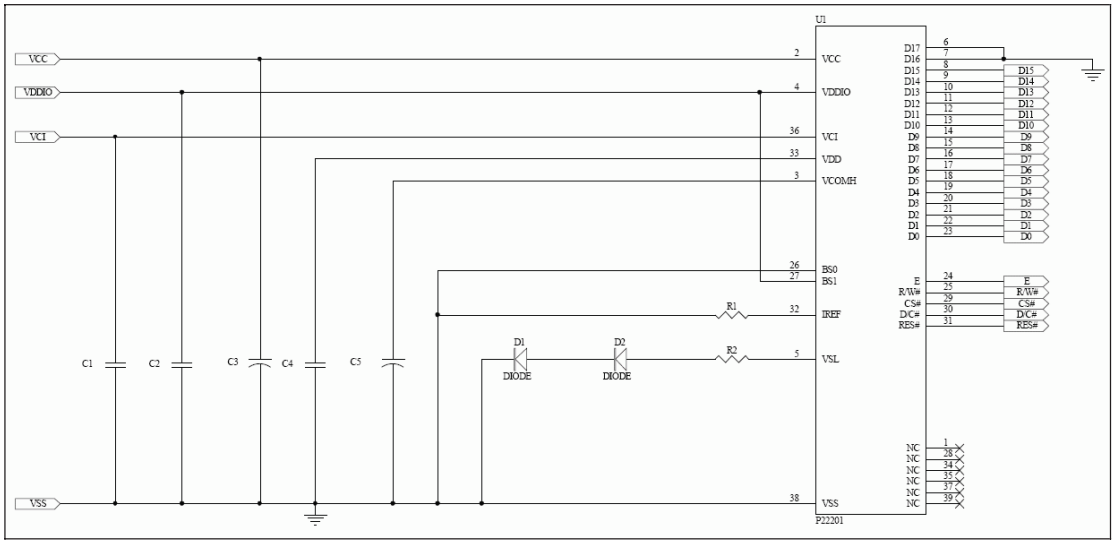
262k Color Depth Graphic Display Data RAM Structure

Segment Address	Normal	0			1			2	.....	.....	126	127		
	Remapped	127			126			125	.....	.....	1	0		
Color		A	B	C	A	B	C	A			C	A	B	C
Data Format / Common Address		A5	B5	C5	A5	B5	C5	A5	.....	.....	C5	A5	B5	C5
		A4	B4	C4	A4	B4	C4	A4	.....	.....	C4	A4	B4	C4
		A3	B3	C3	A3	B3	C3	A3	.....	.....	C3	A3	B3	C3
		A2	B2	C2	A2	B2	C2	A2	.....	.....	C2	A2	B2	C2
		A1	B1	C1	A1	B1	C1	A1	.....	.....	C1	A1	B1	C1
		A0	B0	C0	A0	B0	C0	A0	.....	.....	C0	A0	B0	C0
Normal	Remapped													
0	127	6	6	6	6	6	6	6	.....	.....	6	6	6	6
1	126	6	6	6	6	6	6	6	.....	.....	6	6	6	6
2	125	6	6	6	6	6	6	6	.....	.....	6	6	6	6
3	124	6	6	6	6	6	6	6	.....	.....	6	6	6	6
4	123	6	6	6	6	6	6	6	.....	.....	6	6	6	6
5	122	6	6	6	6	6	6	6	.....	.....	6	6	6	6
6	121	6	6	no of bits in this cell			6	6	.....	.....	6	6	6	6
7	120								.....	.....	6	6	6	6
:	:	:	:	:	:	:	:	:	.....	.....	:	:	:	:
:	:	:	:	:	:	:	:	:	.....	.....	:	:	:	:
:	:	:	:	:	:	:	:	:	.....	.....	:	:	:	:
123	4	6	6	6	6	6	6	6	.....	.....	6	6	6	6
124	3	6	6	6	6	6	6	6	.....	.....	6	6	6	6
125	2	6	6	6	6	6	6	6	.....	.....	6	6	6	6
126	1	6	6	6	6	6	6	6	.....	.....	6	6	6	6
127	0	6	6	6	6	6	6	6	.....	.....	6	6	6	6

Common output
COM0
COM1
COM2
COM3
COM4
COM5
COM6
COM7
:
:
:
:
COM124
COM125
COM126
COM127

SEG output	SA0	SB0	SC0	SA1	SB1	SC1	SA2	.....	.....	SC126	SA127	SB127	SC127

3. Application Circuit



Recommend components:

C1, C2, C4: 1uF/16V(0805)

C3, C5: 4.7uF/35V (Tantalum type) or VISHAY (572D475X0025A2T)

R1: 1M ohm 1%(0603)

R2: 50 ohm 1/4W

D1, D2: RB480K(ROHM)

This circuit is for 8080 8 bits interface

4. Command Table

Refer to SSD1351 IC Spec.

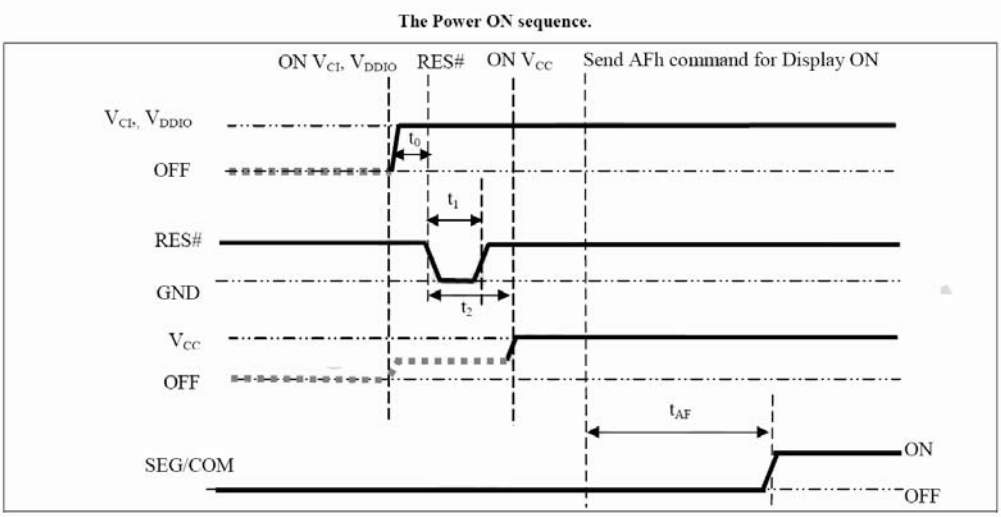
■ TIMING OF POWER SUPPLY

1.POWER ON/OFF SEQUENCE

The following figures illustrate the recommended power ON and power OFF sequence of SSD1351 (assume V_{CI} and V_{DDIO} are at the same voltage level and internal V_{DD} is used).

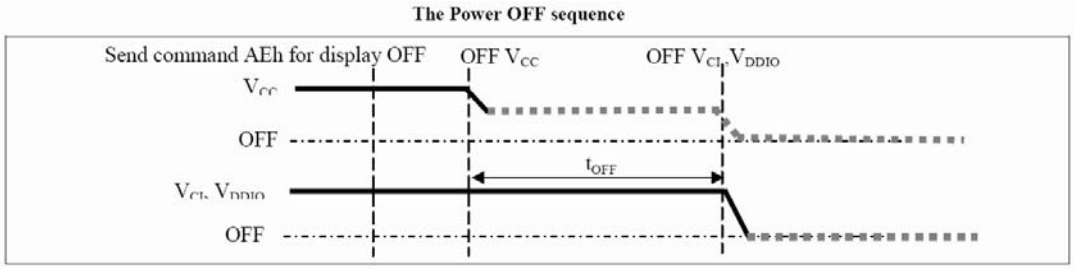
***Power ON sequence*:**

1. Power ON V_{CI}, V_{DDIO}.
2. After V_{CI}, V_{DDIO} become stable, set wait time at least 1ms (t_0) for internal V_{DD} become stable. Then set RES# pin LOW (logic low) for at least 2us (t_1) (4) and then HIGH (logic high).
3. After set RES# pin LOW (logic low), wait for at least 2us (t_2). Then Power ON V_{CC}.(1)
4. After V_{CC} become stable, send command AFh for display ON. SEG/COM will be ON after 200ms(t_{AF}).



***Power OFF sequence*:**

1. Send command AEh for display OFF.
2. Power OFF V_{CC}.(1), (2)
3. Wait for t_{OFF}. Power OFF V_{CI}, V_{DDIO}.(where Minimum t_{OFF}=80ms (3), Typical t_{OFF}=100ms)



Note:

(1) Since an ESD protection circuit is connected between V_{CI}, V_{DDIO} and V_{CC}, V_{CC} becomes lower than V_{CI} whenever V_{CI}, V_{DDIO} is ON and V_{CC} is OFF as shown in the dotted line of V_{CC} in above figures.

(2) V_{CC} should be kept float (disable) when it is OFF.

(3) V_{CI}, V_{DDIO} should not be Power OFF before V_{CC} Power OFF.

(4) The register values are reset after t_1.

(5) Power pins (V_{DD}, V_{CC}) can never be pulled to ground under any circumstance.

■ ELECTRO-OPTICAL CHARACTERISTICS (Ta=25℃)

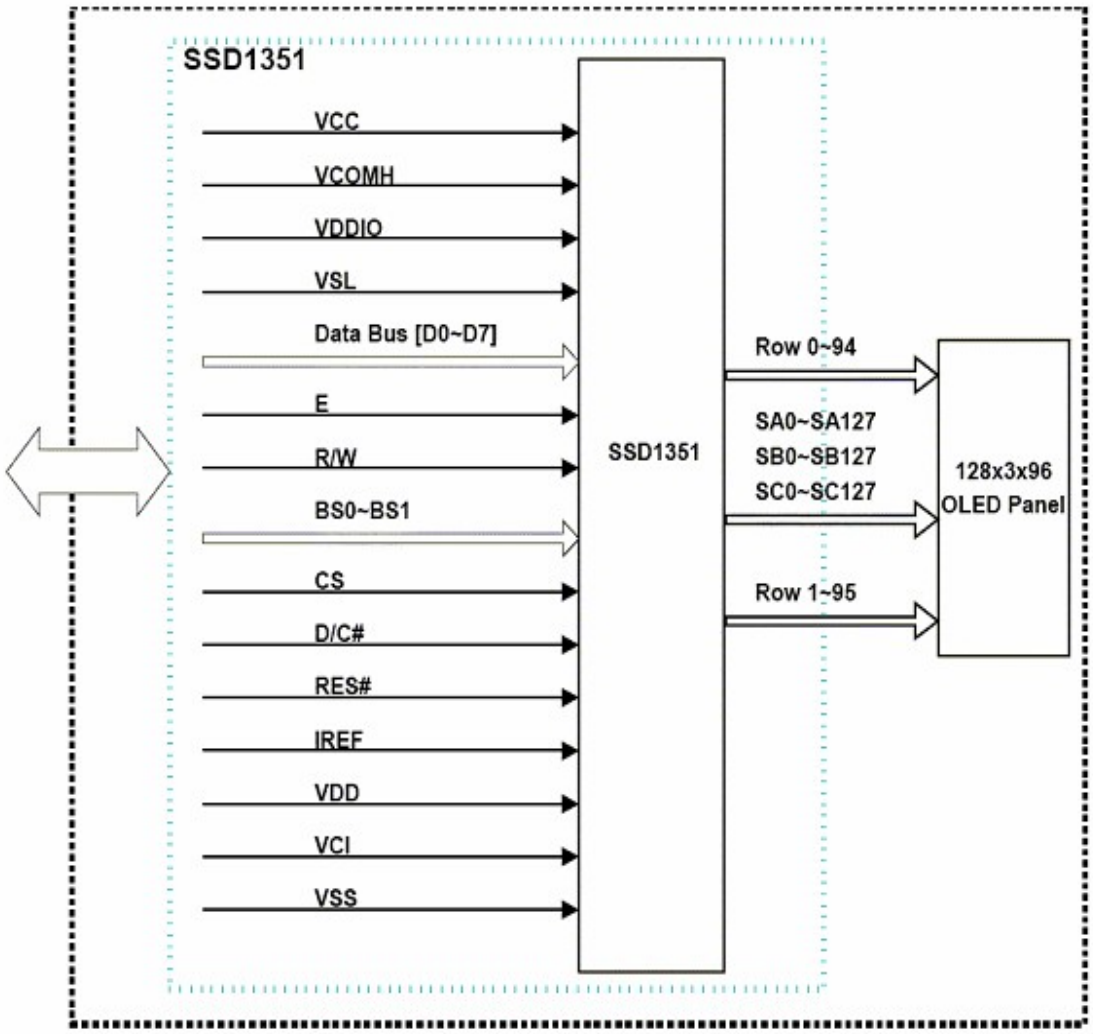
Items		Symbol	Min.	Typ.	Max.	Unit	Remark
Normal mode luminance		L	70	90	-	cd /m^2	Display average
Standby mode luminance		L	-	40	-	cd /m^2	
Response time		-	-	10	-	μs	
Normal mode current		-	-	20	22	mA	1
Standby mode current		-	-	3	5	mA	2
Normal mode power consumption		-	-	300	330	mW	1
Standby mode power consumption		-	-	45	75	mW	2
Color Coordinate	White	CIE x	0.24	0.28	0.32	CIE1931	Darkroom
		CIE y	0.28	0.32	0.36		
	Red	CIE x	0.62	0.66	0.70		
		CIE y	0.29	0.33	0.37		
	Green	CIE x	0.26	0.30	0.34		
		CIE y	0.59	0.63	0.67		
	Blue	CIE x	0.10	0.14	0.18		
		CIE y	0.14	0.18	0.22		
Contrast Ratio*		Cr	20000 :1	-	-		Darkroom
Viewing Angle Uniformity		△ θ	160	-	-	Degree	-

(1) Normal mode condition :
- Driving Voltage : 15V
- Contrast setting : 0x07
- Frame rate : 105Hz
- Duty setting : 1/96

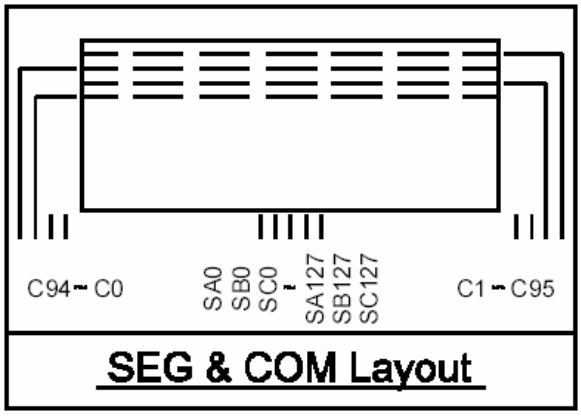
(2) Standby mode condition :
- Driving Voltage : 15V
- Contrast setting : 0x04
- Frame rate : 105Hz
- Duty setting : 1/96

■ INTERFACE PIN CONNECTIONS

1.FUNCTION BLOCK DIAGRAM



2.PANEL LAYOUT DIAGRAM



3.PIN ASSIGNMENTS

PIN NAME	PIN NO	DESCRIPTION
NC	1	No connection.
VCC	2	Power supply for panel driving voltage.
VCOMH	3	COM signal deselected voltage level. A capacitor should be connected between this pin an VSS.
VDDIO	4	Power supply for interface logic level.
VSL	5	This is segment voltage reference pin.
NC	6	No connection.
D7	7	These pins are bi-directional data bus connecting to the MCU data bus.
D6	8	
D5	9	
D4	10	
D3	11	
D2	12	
D1	13	
D0	14	
E	15	8080: data read enable pin; 6800:Read/Write enable pin.
R/W	16	8080: data write enable pin; 6800:Read/Write select pin.
BS0	17	Interface select pin.
BS1	18	Interface select pin.
CS	19	Chip select pin.
D/C#	20	H: Data, L: Command.
RES#	21	Hardware Reset pin (Low active).
IREF	22	A resistor should be connected between this pin and VSS.
NC	23	No connection.
NC	24	No connection.
NC	25	No connection.
VDD	26	Power supply pin for core logic operation.
VCI	27	Digital voltage power supply.
VSS	28	Ground.
VCC	29	Power supply for panel driving voltage.
NC	30	No connection.

■ RELIABILITY TESTS

Item		Condition	Criterion
High Temperature Storage (HTS)		85±2℃, 240 hours	1. After testing, the function test is ok. 2. After testing, no addition to the defect. 3. After testing, the change of luminance should be within +/- 50% of initial value. 4. After testing, the change for the mono and area color must be within (+/-0.02, +/-0.02) and for the full color it must be within (+/-0.04, +/-0.04) of initial value based on 1931 CIE coordinates. 5. After testing, the change of total current consumption should be within +/- 50% of initial value.
High Temperature Operating (HTO)		70±2℃, 120 hours	
Low Temperature Storage (LTS)		-40±2℃, 240 hours	
Low Temperature Operating (LTO)		-40±2℃, 120 hours	
High Temperature / High Humidity Storage (HTHHS)		65±3℃, 90%±3%RH, 96 hours	
Thermal Shock (Non-operation) (TS)		-40±2℃ ~ 25℃ ~ 85±2℃ (30min) (5min) (30min) 20cycles	
Vibration (Packing)	10~55~10Hz,amplitude 1.5mm, 1 hour for each direction x, y, z	1. One box for each test. 2. No addition to the cosmetic and the electrical defects.	
Drop (Packing)	Height : 1 m, each time for 6 sides, 3 edges, 1 angle		

Note： 1) For each reliability test, the sample quantity is 3, and only for one test item.
2) The HTHHS test is requested the Pure Water(Resistance＞10MΩ).

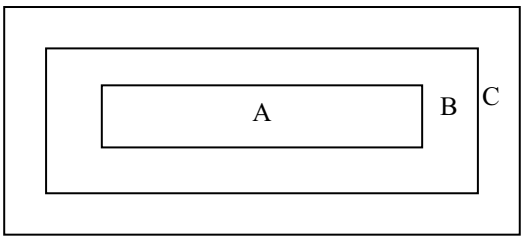
■OUTGOING QUALITY CONTROL SPECIFICATION

◆Standard

According to GB/T2828.1-2003/ISO 2859-1： 1999 and ANSI/ASQC Z1.4-1993, General Inspection Level II.

◆Definition

1 Major defect : The defect that greatly affect the usability of product.
2 Minor defect : The other defects, such as cosmetic defects, etc.
3 Definition of inspection zone:



Zone A: Active Area

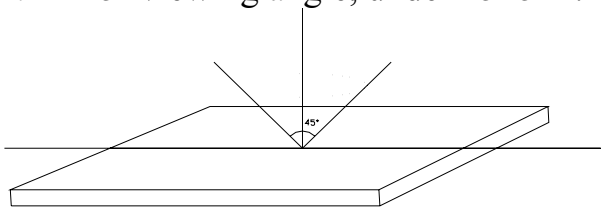
Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer`s product.

◆Inspection Methods

1 The general inspection : under 20W x 2 or 40W fluorescent light, about 30cm viewing distance, within 45º viewing angle, under 25±5℃.



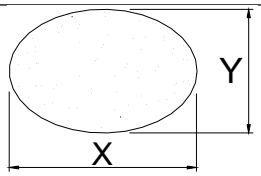
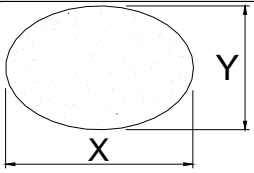
2 The luminance and color coordinate inspection : By PR705 or BM-7 or the equal equipments, in the dark room, under 25±5℃.

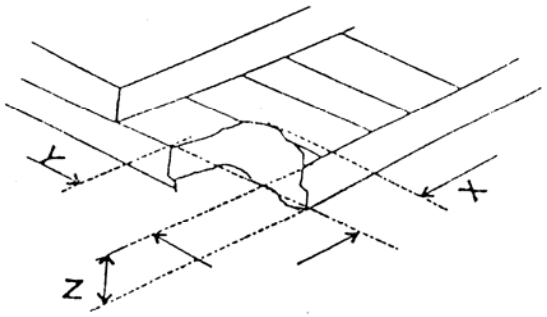
◆Inspection Criteria

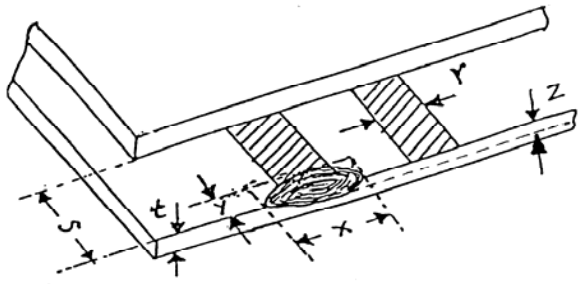
1 Major defect : AQL= 0.65

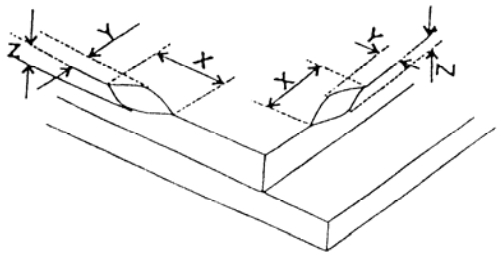
Item	Criterion
Function Defect	1. No display or abnormal display is not accepted
	2. Open or short is not accepted.
	3. Power consumption exceeding the spec is not accepted.
Outline Dimension	Outline dimension exceeding the spec is not accepted.
Glass Crack	Glass crack tends to enlarge is not accepted.

2 Minor Defect : AQL= 1.5

<table>
<tr><td>Item</td><td colspan="4">Criterion</td></tr>
<tr><td rowspan="6">Spot Defect (dimming and lighting spot)</td><td colspan="2" rowspan="2">Size (mm)</td><td colspan="2">Accepted Qty</td></tr>
<tr><td>Area A + Area B</td><td>Area C</td></tr>
<tr><td rowspan="4">  </td><td>Φ≦0.10</td><td colspan="2">Ignored</td></tr>
<tr><td>0.10＜Φ≦0.15</td><td>3</td><td rowspan="3">Ignored</td></tr>
<tr><td>0.15＜Φ≦0. 20</td><td>1</td></tr>
<tr><td>0.20＜Φ</td><td>0</td></tr>
<tr><td colspan="4">Note : Φ= (x + y) / 2</td></tr>
<tr><td rowspan="5">Line Defect (dimming and lighting line)</td><td>L (Length) : mm</td><td>W (Width) : mm</td><td>Area A + Area B</td><td>Area C</td></tr>
<tr><td>/</td><td>W≦0.03</td><td colspan="2">Ignored</td></tr>
<tr><td>L≦3.0</td><td>0.03＜W≦0.05</td><td>2</td><td rowspan="3">Ignored</td></tr>
<tr><td>L≦2.0</td><td>0.05＜W≦0.08</td><td>1</td></tr>
<tr><td>/</td><td>0.08＜W</td><td>As spot defect</td></tr>
<tr><td colspan="5">Remarks: The total of spot defect and line defect shall not exceed 4 pcs.</td></tr>
<tr><td>Polarizer Stain</td><td colspan="4">Stain which can be wiped off lightly with a soft cloth or similar cleaning is accepted, otherwise, according to the Spot Defect and the Line Defect.</td></tr>
<tr><td rowspan="7">Polarizer Scratch</td><td colspan="4">1. If scratch can be seen during operation, according to the criterions of the Spot Defect and the Line Defect.</td></tr>
<tr><td colspan="4">2. If scratch can be seen only under non-operation or some special angle, the criterion is as below :</td></tr>
<tr><td>L (Length) : mm</td><td>W (Width) : mm</td><td>Area A + Area B</td><td>Area C</td></tr>
<tr><td>/</td><td>W≦0.03</td><td colspan="2">Ignore</td></tr>
<tr><td>5.0＜L≦10.0</td><td>0.03＜W≦0.05</td><td>2</td><td rowspan="3">Ignore</td></tr>
<tr><td>L≦5.0</td><td>0.05＜W≦0.08</td><td>1</td></tr>
<tr><td>/</td><td>0.08＜W</td><td>0</td></tr>
<tr><td rowspan="5">Polarizer Air Bubble</td><td colspan="2">Size</td><td>Area A + Area B</td><td>Area C</td></tr>
<tr><td rowspan="4">  </td><td>Φ≦0.20</td><td colspan="2">Ignored</td></tr>
<tr><td>0.20＜Φ≦0.50</td><td>2</td><td rowspan="3">Ignored</td></tr>
<tr><td>0.50＜Φ≦0.80</td><td>1</td></tr>
<tr><td>0.80＜Φ</td><td>0</td></tr>
</table>

<table>
<tr><td rowspan="4">Glass Defect (Glass Chiped)</td><td>1. On the corner
(mm)
 

<table><tr><td>x</td><td>≤ 2.0</td></tr><tr><td>y</td><td>≤ S</td></tr><tr><td>z</td><td>≤ t</td></tr></table></td></tr>
<tr><td>2. On the bonding edge
(mm)
 

<table><tr><td>x</td><td>≤ a / 2</td></tr><tr><td>y</td><td>≤ s / 3</td></tr><tr><td>z</td><td>≤ t</td></tr></table></td></tr>
<tr><td>3. On the other edges
(mm)
 

<table><tr><td>x</td><td>≤ a / 5</td></tr><tr><td>y</td><td>≤ 1.0</td></tr><tr><td>z</td><td>≤ t</td></tr></table></td></tr>
<tr><td>Note: t: glass thickness ; s: pad width ; a: the length of the edge</td></tr>
<tr><td>TCP Defect</td><td>Crack, deep fold and deep pressure mark on the TCP are not accepted</td></tr>
<tr><td>Pixel Size</td><td>The tolerance of display pixel dimension should be within ±20% of the spec</td></tr>
<tr><td>Luminance</td><td>Refer to the spec or the reference sample</td></tr>
<tr><td>Color</td><td>Refer to the spec or the reference sample</td></tr>
</table>

■ CAUTIONS IN USING OLED MODULE

◆Precautions For Handling OLED Module:

1. OLED module consists of glass and polarizer. Pay attention to the following items when handling:
   i. Avoid drop from high, avoid excessive impact and pressure.
   ii. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead.
   iii. If the surface becomes dirty, breathe on the surface and gently wipe it off with a soft dry cloth. If it is terrible dirty, moisten the soft cloth with Isopropyl alcohol or Ethyl alcohol. Other solvents may damage the polarizer. Especially water, Ketone and Aromatic solvents.
   iv. Wipe off saliva or water drops immediately, contact the polarizer with water over a long period of time may cause deformation.
   v. Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peeling-off may occur with high temperature and high humidity.
   vi. Condensation on the surface and the terminals due to cold or anything will damage, stain or dirty the polarizer, so make it clean as the way of iii.
2. Do not attempt to disassemble or process the OLED Module.
3. Make sure the TCP or the FPC of the Module is free of twisting, warping and distortion, do not pull or bend them forcefully, especially the soldering pins. On the other side, the SLIT part of the TCP is made to bend in the necessary case.
4. When assembling the module into other equipment, give the glass enough space to avoid excessive pressure on the glass, especially the glass cover which is much more fragile.
5. Be sure to keep the air pressure under 120 kPa, otherwise the glass cover is to be cracked.
6. Be careful to prevent damage by static electricity:
   i. Be sure to ground the body when handling the OLED Modules.
   ii. All machines and tools required for assembling, such as soldering irons, must be properly grounded.
   iii. Do not assemble and do no other work under dry conditions to reduce the amount of static electricity generated. A relative humidity of 50%-60% is recommended.
   iv. Peel off the protective film slowly to avoid the amount of static electricity generated.
   v. Avoid to touch the circuit, the soldering pins and the IC on the Module by the body.
   vi. Be sure to use anti-static package.
7. Contamination on terminals can cause an electrochemical reaction and corrade the terminal circuit, so make it clean anytime.
8. All terminals should be open, do not attach any conductor or semiconductor on the terminals.
9. When the logic circuit power is off, do not apply the input signals.
10. Power on sequence: $V_{DD} \rightarrow V_{PP}$, and power off sequence: $V_{PP} \rightarrow V_{DD}$.
11. Be sure to keep temperature, humidity and voltage within the ranges of the spec, otherwise shorten Module’ s life time, even make it damaged.
12. Be sure to drive the OLED Module following the Specification and Datasheet of IC controller, otherwise something wrong may be seen.

13. When displaying images, keep them rolling, and avoid one fixed image displaying more than 30 seconds, otherwise the residue image is to be seen. This is the speciality of OLED.

◆Precautions For Soldering OLED Module:

1. Soldering temperature : 260°C ± 10°C.
2. Soldering time : 3-4 sec.
3. Repeating time : no more than 3 times.
4. If soldering flux is used, be sure to remove any remaining flux after finishing soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended to protect the surface with a cover during soldering to prevent any damage due to flux spatters.

◆ Precautions For Storing OLED Module:

1. Be sure to store the OLED Module in the vacuum bag with dessicant.
2. If the Module can not be used up in 1 month after the bag being opened, make sure to seal the Module in the vacuum bag with dessicant again.
3. Store the Module in a dark place, do not expose to sunlight or fluorescent light.
4. The polarizer surface should not touch any other objects. It is recommended to store the Module in the shipping container.
5. It is recommended to keep the temperature between 0°C and 30°C , the relative humidity not over 60%.

◆ Limited Warranty

Unless relevant quality agreements signed with customer and law enforcement, for a period of 12 months from date of production, all products (except automotive products) Multi-Inno will replace or repair any of its OLED modules which are found to be functional defect when inspected in accordance with Multi-Inno OLED acceptance standards (copies available upon request). Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date should be based on freight documents. The warranty liability of Multi-Inno is limited to repair and/or replacement on the terms above. Multi-Inno will not be responsible for any subsequent or consequential events.

◆Return OLED Module Under Warranty:

1. No warranty in the case that the precautions are disregarded.
2. Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects.